Ref #	Hits	Search Query	DBs	Default Operat or	Plura Is	Time Stamp
L1	211121	polyorganosiloxane or diorganopolysiloxane or polysiloxane or dimethylpolysiloxane or diphenylpolysiloxaneor methylphenylpolysiloxane or phenylmethylpolysiloxane or (silicone adj (rubber or oil))	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	OR	ON	2006/08/18 10:29
L2	303613	((epox?\$3 or epoxidi?ed or epoxidat?\$3 or epoxylat?\$3) near3 (novola?\$1 or resin\$3)) or diepox?\$3 or polyepox?\$3 or diglycidyl? or polyglycidyl?	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	OR	ON	2006/08/18 10:31
L3	313303	((epox?\$3 or epoxidi?ed or epoxidat?\$3 or epoxylat?\$3) near3 (novola?\$1 or resin\$3)) or diepox?\$3 or polyepox?\$3 or diglycidyl\$ or polyglycidyl\$	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	OR	ON	2006/08/18 10:31
L4	116543	(phenol\$2 or cresol\$2) adj (resin or novola?\$1)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	OR	ON	2006/08/18 10:33

L5	888056	silica or alumina or Al2O3 or ((aluminum or Al) adj oxide)	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	OR	ON	2006/08/18 10:45
L6	6704	I1 and I3 and I4 and I5	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	OR	ON	2006/08/18 10:34
L7	372714 0	semiconductor or (semi adj conductor) or electronic or (ball adj grid adj array) or BGA or (chip adj (size or scale) adj package) or CSP or (quad adj flat adj package) or QFP or (small adj outline adj package) or SOP	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	OR	ON	2006/08/18 10:37
L8	3230	l6 and l7	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	OR	ON	2006/08/18 10:37

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L9	204	18	EPO; JPO; DERWEN T; IBM_TD B	OR	ON	2006/08/18 10:45	
L10	193381	silica and (alumina or Al2O3 or ((aluminum or Al) adj oxide))	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	OR	ON	2006/08/18 10:45	
L11	2181	I1 and I3 and I4 and 7 and I10	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	OR	ON	2006/08/18 10:46	
L12	23	l11	FPRS; EPO; JPO; DERWEN T; IBM_TD B	OR	ON	2006/08/18 13:06	
L13	2	jp-01009214-\$.did.	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T; IBM_TD B	OR	ON	2006/08/18 13:08	

L14	2	jp-63275625-\$.did.	US-PGPU B; USPAT; USOCR; EPO; JPO; DERWEN T;	OR	ON	2006/08/18 13:08
			IBM_TD			